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### Understanding Embedded - FPGAs (Field Programmable Gate Array)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

### Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

#### Details

|                                |   |
|--------------------------------|---|
| Product Status                 | Obsolete  |
| Number of LABs/CLBs            | 185000  |
| Number of Logic Elements/Cells | 490000  |
| Total RAM Bits                 | 46080000  |
| Number of I/O                  | 600   |
| Number of Gates                | -   |
| Voltage - Supply               | 0.82V ~ 0.88V   |
| Mounting Type                  | Surface Mount   |
| Operating Temperature          | 0°C ~ 85°C (TJ)   |
| Package / Case                 | 1517-BBGA, FCBGA  |
| Supplier Device Package        | 1517-FBGA (40x40)   |
| Purchase URL                   | <a href="https://www.e-xfl.com/product-detail/intel/5sgxea5n1f40c2l">https://www.e-xfl.com/product-detail/intel/5sgxea5n1f40c2l</a> |

**Table 1. Stratix V GX and GS Commercial and Industrial Speed Grade Offering <sup>(1), (2), (3)</sup> (Part 2 of 2)**

| Transceiver Speed Grade  | Core Speed Grade |         |     |     |         |         |                    |     |
|--------------------------|------------------|---------|-----|-----|---------|---------|--------------------|-----|
|                          | C1               | C2, C2L | C3  | C4  | I2, I2L | I3, I3L | I3YY               | I4  |
| 3<br>GX channel—8.5 Gbps | —                | Yes     | Yes | Yes | —       | Yes     | Yes <sup>(4)</sup> | Yes |

**Notes to Table 1:**

- (1) C = Commercial temperature grade; I = Industrial temperature grade.  
 (2) Lower number refers to faster speed grade.  
 (3) C2L, I2L, and I3L speed grades are for low-power devices.  
 (4) I3YY speed grades can achieve up to 10.3125 Gbps.

Table 2 lists the industrial and commercial speed grades for the Stratix V GT devices.

**Table 2. Stratix V GT Commercial and Industrial Speed Grade Offering <sup>(1), (2)</sup>**

| Transceiver Speed Grade                            | Core Speed Grade |     |     |     |
|--|------------------|-----|-----|-----|
|  | C1               | C2  | I2  | I3  |
| 2<br>GX channel—12.5 Gbps<br>GT channel—28.05 Gbps | Yes              | Yes | —   | —   |
| 3<br>GX channel—12.5 Gbps<br>GT channel—25.78 Gbps | Yes              | Yes | Yes | Yes |

**Notes to Table 2:**

- (1) C = Commercial temperature grade; I = Industrial temperature grade.  
 (2) Lower number refers to faster speed grade.

**Absolute Maximum Ratings**

Absolute maximum ratings define the maximum operating conditions for Stratix V devices. The values are based on experiments conducted with the devices and theoretical modeling of breakdown and damage mechanisms. The functional operation of the device is not implied for these conditions.



Conditions other than those listed in Table 3 may cause permanent damage to the device. Additionally, device operation at the absolute maximum ratings for extended periods of time may have adverse effects on the device.

**Table 3. Absolute Maximum Ratings for Stratix V Devices (Part 1 of 2)**

| Symbol              | Description  | Minimum | Maximum | Unit |
|---------------------|--|---------|---------|------|
| V <sub>CC</sub>     | Power supply for core voltage and periphery circuitry                  | −0.5    | 1.35    | V    |
| V <sub>CCPT</sub>   | Power supply for programmable power technology                         | −0.5    | 1.8     | V    |
| V <sub>CCPGM</sub>  | Power supply for configuration pins                                    | −0.5    | 3.9     | V    |
| V <sub>CC_AUX</sub> | Auxiliary supply for the programmable power technology                 | −0.5    | 3.4     | V    |
| V <sub>CCBAT</sub>  | Battery back-up power supply for design security volatile key register | −0.5    | 3.9     | V    |
| V <sub>CCPD</sub>   | I/O pre-driver power supply  | −0.5    | 3.9     | V    |
| V <sub>CCIO</sub>   | I/O power supply   | −0.5    | 3.9     | V    |

**Table 11. OCT Calibration Accuracy Specifications for Stratix V Devices <sup>(1)</sup> (Part 2 of 2)**

| Symbol   | Description  | Conditions                                    | Calibration Accuracy |            |                |            | Unit |
|--|--|---|----------------------|------------|----------------|------------|------|
|  |  |   | C1                   | C2,I2      | C3,I3,<br>I3YY | C4,I4      |      |
| 50-Ω R <sub>S</sub>                              | Internal series termination with calibration (50-Ω setting)                                      | V <sub>CCIO</sub> = 3.0, 2.5, 1.8, 1.5, 1.2 V | ±15                  | ±15        | ±15            | ±15        | %    |
| 34-Ω and 40-Ω R <sub>S</sub>                     | Internal series termination with calibration (34-Ω and 40-Ω setting)                             | V <sub>CCIO</sub> = 1.5, 1.35, 1.25, 1.2 V    | ±15                  | ±15        | ±15            | ±15        | %    |
| 48-Ω, 60-Ω, 80-Ω, and 240-Ω R <sub>S</sub>       | Internal series termination with calibration (48-Ω, 60-Ω, 80-Ω, and 240-Ω setting)               | V <sub>CCIO</sub> = 1.2 V                     | ±15                  | ±15        | ±15            | ±15        | %    |
| 50-Ω R <sub>T</sub>                              | Internal parallel termination with calibration (50-Ω setting)                                    | V <sub>CCIO</sub> = 2.5, 1.8, 1.5, 1.2 V      | -10 to +40           | -10 to +40 | -10 to +40     | -10 to +40 | %    |
| 20-Ω, 30-Ω, 40-Ω, 60-Ω, and 120-Ω R <sub>T</sub> | Internal parallel termination with calibration (20-Ω, 30-Ω, 40-Ω, 60-Ω, and 120-Ω setting)       | V <sub>CCIO</sub> = 1.5, 1.35, 1.25 V         | -10 to +40           | -10 to +40 | -10 to +40     | -10 to +40 | %    |
| 60-Ω and 120-Ω R <sub>T</sub>                    | Internal parallel termination with calibration (60-Ω and 120-Ω setting)                          | V <sub>CCIO</sub> = 1.2                       | -10 to +40           | -10 to +40 | -10 to +40     | -10 to +40 | %    |
| 25-Ω R <sub>S_left_shift</sub>                   | Internal left shift series termination with calibration (25-Ω R <sub>S_left_shift</sub> setting) | V <sub>CCIO</sub> = 3.0, 2.5, 1.8, 1.5, 1.2 V | ±15                  | ±15        | ±15            | ±15        | %    |

**Note to Table 11:**

(1) OCT calibration accuracy is valid at the time of calibration only.

Table 12 lists the Stratix V OCT without calibration resistance tolerance to PVT changes.

**Table 12. OCT Without Calibration Resistance Tolerance Specifications for Stratix V Devices (Part 1 of 2)**

| Symbol                      | Description  | Conditions                        | Resistance Tolerance |       |                 |        | Unit |
|-----------------------------|--|-----------------------------------|----------------------|-------|-----------------|--------|------|
|                             |  |                                   | C1                   | C2,I2 | C3, I3,<br>I3YY | C4, I4 |      |
| 25-Ω R, 50-Ω R <sub>S</sub> | Internal series termination without calibration (25-Ω setting) | V <sub>CCIO</sub> = 3.0 and 2.5 V | ±30                  | ±30   | ±40             | ±40    | %    |
| 25-Ω R <sub>S</sub>         | Internal series termination without calibration (25-Ω setting) | V <sub>CCIO</sub> = 1.8 and 1.5 V | ±30                  | ±30   | ±40             | ±40    | %    |
| 25-Ω R <sub>S</sub>         | Internal series termination without calibration (25-Ω setting) | V <sub>CCIO</sub> = 1.2 V         | ±35                  | ±35   | ±50             | ±50    | %    |

**Table 13. OCT Variation after Power-Up Calibration for Stratix V Devices (Part 2 of 2) <sup>(1)</sup>**

| Symbol | Description  | V <sub>CCIO</sub> (V) | Typical | Unit              |
|--------|--|-----------------------|---------|-------------------|
| dR/dT  | OCT variation with temperature without recalibration | 3.0                   | 0.189   | %/ <sup>o</sup> C |
|        |  | 2.5                   | 0.208   |                   |
|        |  | 1.8                   | 0.266   |                   |
|        |  | 1.5                   | 0.273   |                   |
|        |  | 1.2                   | 0.317   |                   |

**Note to Table 13:**

(1) Valid for a V<sub>CCIO</sub> range of  $\pm 5\%$  and a temperature range of 0° to 85°C.

**Pin Capacitance**

Table 14 lists the Stratix V device family pin capacitance.

**Table 14. Pin Capacitance for Stratix V Devices**

| Symbol             | Description  | Value | Unit |
|--------------------|--|-------|------|
| C <sub>IOTB</sub>  | Input capacitance on the top and bottom I/O pins                 | 6     | pF   |
| C <sub>IOLR</sub>  | Input capacitance on the left and right I/O pins                 | 6     | pF   |
| C <sub>OUTFB</sub> | Input capacitance on dual-purpose clock output and feedback pins | 6     | pF   |

**Hot Socketing**

Table 15 lists the hot socketing specifications for Stratix V devices.

**Table 15. Hot Socketing Specifications for Stratix V Devices**

| Symbol                    | Description                                | Maximum             |
|---------------------------|--|---------------------|
| I <sub>IOPIN</sub> (DC)   | DC current per I/O pin                     | 300 $\mu$ A         |
| I <sub>IOPIN</sub> (AC)   | AC current per I/O pin                     | 8 mA <sup>(1)</sup> |
| I <sub>XCVR-TX</sub> (DC) | DC current per transceiver transmitter pin | 100 mA              |
| I <sub>XCVR-RX</sub> (DC) | DC current per transceiver receiver pin    | 50 mA               |

**Note to Table 15:**

(1) The I/O ramp rate is 10 ns or more. For ramp rates faster than 10 ns,  $|I_{IOPIN}| = C \, dv/dt$ , in which C is the I/O pin capacitance and dv/dt is the slew rate.

**Table 23. Transceiver Specifications for Stratix V GX and GS Devices <sup>(1)</sup> (Part 3 of 7)**

| Symbol/<br>Description   | Conditions   | Transceiver Speed<br>Grade 1                         |     |       | Transceiver Speed<br>Grade 2 |     |       | Transceiver Speed<br>Grade 3 |     |                                     | Unit |
|--|--|--|-----|-------|------------------------------|-----|-------|------------------------------|-----|-------------------------------------|------|
|  |  | Min  | Typ | Max   | Min                          | Typ | Max   | Min                          | Typ | Max                                 |      |
| Reconfiguration clock<br>( <code>mgmt_clk_clk</code> )<br>frequency  | —  | 100  | —   | 125   | 100                          | —   | 125   | 100                          | —   | 125                                 | MHz  |
| <b>Receiver</b>  |  |  |     |       |                              |     |       |                              |     |                                     |      |
| Supported I/O Standards  | —  | 1.4-V PCML, 1.5-V PCML, 2.5-V PCML, LVPECL, and LVDS |     |       |                              |     |       |                              |     |                                     |      |
| Data rate<br>(Standard PCS)<br><sup>(9), (23)</sup>  | —  | 600  | —   | 12200 | 600                          | —   | 12200 | 600                          | —   | 8500/<br>10312.5<br><sup>(24)</sup> | Mbps |
| Data rate<br>(10G PCS) <sup>(9), (23)</sup>  | —  | 600  | —   | 14100 | 600                          | —   | 12500 | 600                          | —   | 8500/<br>10312.5<br><sup>(24)</sup> | Mbps |
| Absolute $V_{MAX}$ for<br>a receiver pin <sup>(5)</sup>  | —  | —  | —   | 1.2   | —                            | —   | 1.2   | —                            | —   | 1.2                                 | V    |
| Absolute $V_{MIN}$ for<br>a receiver pin   | —  | −0.4   | —   | —     | −0.4                         | —   | —     | −0.4                         | —   | —                                   | V    |
| Maximum peak-<br>to-peak<br>differential input<br>voltage $V_{ID}$ (diff p-<br>p) before device<br>configuration <sup>(22)</sup>                     | —  | —  | —   | 1.6   | —                            | —   | 1.6   | —                            | —   | 1.6                                 | V    |
| Maximum peak-<br>to-peak<br>differential input<br>voltage $V_{ID}$ (diff p-<br>p) after device<br>configuration <sup>(18)</sup> ,<br><sup>(22)</sup> | $V_{CCR\_GXB} =$<br>1.0 V/1.05 V<br>( $V_{ICM} =$<br>0.70 V) | —  | —   | 2.0   | —                            | —   | 2.0   | —                            | —   | 2.0                                 | V    |
|  | $V_{CCR\_GXB} =$<br>0.90 V<br>( $V_{ICM} = 0.6$ V)           | —  | —   | 2.4   | —                            | —   | 2.4   | —                            | —   | 2.4                                 | V    |
|  | $V_{CCR\_GXB} =$<br>0.85 V<br>( $V_{ICM} = 0.6$ V)           | —  | —   | 2.4   | —                            | —   | 2.4   | —                            | —   | 2.4                                 | V    |
| Minimum<br>differential eye<br>opening at<br>receiver serial<br>input pins <sup>(6), (22)</sup> ,<br><sup>(27)</sup>                                 | —  | 85   | —   | —     | 85                           | —   | —     | 85                           | —   | —                                   | mV   |

**Table 23. Transceiver Specifications for Stratix V GX and GS Devices <sup>(1)</sup> (Part 5 of 7)**

| Symbol/<br>Description  | Conditions   | Transceiver Speed<br>Grade 1 |                     |       | Transceiver Speed<br>Grade 2 |                     |       | Transceiver Speed<br>Grade 3 |                     |                                     | Unit     |
|---|--|------------------------------|---------------------|-------|------------------------------|---------------------|-------|------------------------------|---------------------|-------------------------------------|----------|
|   |  | Min                          | Typ                 | Max   | Min                          | Typ                 | Max   | Min                          | Typ                 | Max                                 |          |
| Programmable<br>DC gain   | DC Gain<br>Setting = 0                                     | —                            | 0                   | —     | —                            | 0                   | —     | —                            | 0                   | —                                   | dB       |
|   | DC Gain<br>Setting = 1                                     | —                            | 2                   | —     | —                            | 2                   | —     | —                            | 2                   | —                                   | dB       |
|   | DC Gain<br>Setting = 2                                     | —                            | 4                   | —     | —                            | 4                   | —     | —                            | 4                   | —                                   | dB       |
|   | DC Gain<br>Setting = 3                                     | —                            | 6                   | —     | —                            | 6                   | —     | —                            | 6                   | —                                   | dB       |
|   | DC Gain<br>Setting = 4                                     | —                            | 8                   | —     | —                            | 8                   | —     | —                            | 8                   | —                                   | dB       |
| <b>Transmitter</b>  |  |                              |                     |       |                              |                     |       |                              |                     |                                     |          |
| Supported I/O<br>Standards  | —  | 1.4-V and 1.5-V PCML         |                     |       |                              |                     |       |                              |                     |                                     |          |
| Data rate<br>(Standard PCS)   | —  | 600                          | —                   | 12200 | 600                          | —                   | 12200 | 600                          | —                   | 8500/<br>10312.5<br><sup>(24)</sup> | Mbps     |
| Data rate<br>(10G PCS)  | —  | 600                          | —                   | 14100 | 600                          | —                   | 12500 | 600                          | —                   | 8500/<br>10312.5<br><sup>(24)</sup> | Mbps     |
| Differential on-<br>chip termination<br>resistors                     | 85- $\Omega$<br>setting                                    | —                            | 85 $\pm$<br>20%     | —     | —                            | 85 $\pm$<br>20%     | —     | —                            | 85 $\pm$<br>20%     | —                                   | $\Omega$ |
|   | 100- $\Omega$<br>setting                                   | —                            | 100<br>$\pm$<br>20% | —     | —                            | 100<br>$\pm$<br>20% | —     | —                            | 100<br>$\pm$<br>20% | —                                   | $\Omega$ |
|   | 120- $\Omega$<br>setting                                   | —                            | 120<br>$\pm$<br>20% | —     | —                            | 120<br>$\pm$<br>20% | —     | —                            | 120<br>$\pm$<br>20% | —                                   | $\Omega$ |
|   | 150- $\Omega$<br>setting                                   | —                            | 150<br>$\pm$<br>20% | —     | —                            | 150<br>$\pm$<br>20% | —     | —                            | 150<br>$\pm$<br>20% | —                                   | $\Omega$ |
| V <sub>OCM</sub> (AC<br>coupled)                                      | 0.65-V<br>setting  | —                            | 650                 | —     | —                            | 650                 | —     | —                            | 650                 | —                                   | mV       |
| V <sub>OCM</sub> (DC<br>coupled)                                      | —  | —                            | 650                 | —     | —                            | 650                 | —     | —                            | 650                 | —                                   | mV       |
| Rise time <sup>(7)</sup>  | 20% to 80%   | 30                           | —                   | 160   | 30                           | —                   | 160   | 30                           | —                   | 160                                 | ps       |
| Fall time <sup>(7)</sup>  | 80% to 20%   | 30                           | —                   | 160   | 30                           | —                   | 160   | 30                           | —                   | 160                                 | ps       |
| Intra-differential<br>pair skew                                       | Tx V <sub>CM</sub> =<br>0.5 V and<br>slew rate of<br>15 ps | —                            | —                   | 15    | —                            | —                   | 15    | —                            | —                   | 15                                  | ps       |
| Intra-transceiver<br>block transmitter<br>channel-to-<br>channel skew | x6 PMA<br>bonded mode                                      | —                            | —                   | 120   | —                            | —                   | 120   | —                            | —                   | 120                                 | ps       |

Table 24 shows the maximum transmitter data rate for the clock network.

**Table 24. Clock Network Maximum Data Rate Transmitter Specifications <sup>(1)</sup>**

| Clock Network                  | ATX PLL                |                    |                                       | CMU PLL <sup>(2)</sup> |                    |                                       | fPLL                   |                    |                                       |
|--------------------------------|------------------------|--------------------|---------------------------------------|------------------------|--------------------|---------------------------------------|------------------------|--------------------|---------------------------------------|
|                                | Non-bonded Mode (Gbps) | Bonded Mode (Gbps) | Channel Span                          | Non-bonded Mode (Gbps) | Bonded Mode (Gbps) | Channel Span                          | Non-bonded Mode (Gbps) | Bonded Mode (Gbps) | Channel Span                          |
| x1 <sup>(3)</sup>              | 14.1                   | —                  | 6                                     | 12.5                   | —                  | 6                                     | 3.125                  | —                  | 3                                     |
| x6 <sup>(3)</sup>              | —                      | 14.1               | 6                                     | —                      | 12.5               | 6                                     | —                      | 3.125              | 6                                     |
| x6 PLL Feedback <sup>(4)</sup> | —                      | 14.1               | Side-wide                             | —                      | 12.5               | Side-wide                             | —                      | —                  | —                                     |
| xN (PCIe)                      | —                      | 8.0                | 8                                     | —                      | 5.0                | 8                                     | —                      | —                  | —                                     |
| xN (Native PHY IP)             | 8.0                    | 8.0                | Up to 13 channels above and below PLL | 7.99                   | 7.99               | Up to 13 channels above and below PLL | 3.125                  | 3.125              | Up to 13 channels above and below PLL |
|                                | —                      | 8.01 to 9.8304     | Up to 7 channels above and below PLL  |                        |                    |                                       |                        |                    |                                       |

**Notes to Table 24:**

- (1) Valid data rates below the maximum specified in this table depend on the reference clock frequency and the PLL counter settings. Check the MegaWizard message during the PHY IP instantiation.
- (2) ATX PLL is recommended at 8 Gbps and above data rates for improved jitter performance.
- (3) Channel span is within a transceiver bank.
- (4) Side-wide channel bonding is allowed up to the maximum supported by the PHY IP.

Table 25 shows the approximate maximum data rate using the standard PCS.

**Table 25. Stratix V Standard PCS Approximate Maximum Date Rate <sup>(1)</sup>, <sup>(3)</sup>**

| Mode <sup>(2)</sup> | Transceiver Speed Grade | PMA Width                             | 20      | 20      | 16      | 16      | 10  | 10  | 8    | 8    |
|---------------------|-------------------------|---------------------------------------|---------|---------|---------|---------|-----|-----|------|------|
|                     |                         | PCS/Core Width                        | 40      | 20      | 32      | 16      | 20  | 10  | 16   | 8    |
| FIFO                | 1                       | C1, C2, C2L, I2, I2L core speed grade | 12.2    | 11.4    | 9.76    | 9.12    | 6.5 | 5.8 | 5.2  | 4.72 |
|                     | 2                       | C1, C2, C2L, I2, I2L core speed grade | 12.2    | 11.4    | 9.76    | 9.12    | 6.5 | 5.8 | 5.2  | 4.72 |
|                     |                         | C3, I3, I3L core speed grade          | 9.8     | 9.0     | 7.84    | 7.2     | 5.3 | 4.7 | 4.24 | 3.76 |
|                     | 3                       | C1, C2, C2L, I2, I2L core speed grade | 8.5     | 8.5     | 8.5     | 8.5     | 6.5 | 5.8 | 5.2  | 4.72 |
|                     |                         | I3YY core speed grade                 | 10.3125 | 10.3125 | 7.84    | 7.2     | 5.3 | 4.7 | 4.24 | 3.76 |
|                     |                         | C3, I3, I3L core speed grade          | 8.5     | 8.5     | 7.84    | 7.2     | 5.3 | 4.7 | 4.24 | 3.76 |
|                     |                         | C4, I4 core speed grade               | 8.5     | 8.2     | 7.04    | 6.56    | 4.8 | 4.2 | 3.84 | 3.44 |
| Register            | 1                       | C1, C2, C2L, I2, I2L core speed grade | 12.2    | 11.4    | 9.76    | 9.12    | 6.1 | 5.7 | 4.88 | 4.56 |
|                     | 2                       | C1, C2, C2L, I2, I2L core speed grade | 12.2    | 11.4    | 9.76    | 9.12    | 6.1 | 5.7 | 4.88 | 4.56 |
|                     |                         | C3, I3, I3L core speed grade          | 9.8     | 9.0     | 7.92    | 7.2     | 4.9 | 4.5 | 3.96 | 3.6  |
|                     | 3                       | C1, C2, C2L, I2, I2L core speed grade | 10.3125 | 10.3125 | 10.3125 | 10.3125 | 6.1 | 5.7 | 4.88 | 4.56 |
|                     |                         | I3YY core speed grade                 | 10.3125 | 10.3125 | 7.92    | 7.2     | 4.9 | 4.5 | 3.96 | 3.6  |
|                     |                         | C3, I3, I3L core speed grade          | 8.5     | 8.5     | 7.92    | 7.2     | 4.9 | 4.5 | 3.96 | 3.6  |
|                     |                         | C4, I4 core speed grade               | 8.5     | 8.2     | 7.04    | 6.56    | 4.4 | 4.1 | 3.52 | 3.28 |

**Notes to Table 25:**

- (1) The maximum data rate is in Gbps.
- (2) The Phase Compensation FIFO can be configured in FIFO mode or register mode. In the FIFO mode, the pointers are not fixed, and the latency can vary. In the register mode the pointers are fixed for low latency.
- (3) The maximum data rate is also constrained by the transceiver speed grade. Refer to Table 1 for the transceiver speed grade.



Figure 4 shows the differential transmitter output waveform.

**Figure 4. Differential Transmitter/Receiver Output/Input Waveform**



Figure 5 shows the Stratix V AC gain curves for GT channels.

**Figure 5. AC Gain Curves for GT Channels**

**Table 31. PLL Specifications for Stratix V Devices (Part 3 of 3)**

| Symbol    | Parameter  | Min    | Typ  | Max   | Unit |
|-----------|--|--------|------|-------|------|
| $f_{RES}$ | Resolution of VCO frequency ( $f_{INPFD} = 100$ MHz) | 390625 | 5.96 | 0.023 | Hz   |

**Notes to Table 31:**

- (1) This specification is limited in the Quartus II software by the I/O maximum frequency. The maximum I/O frequency is different for each I/O standard.
- (2) This specification is limited by the lower of the two: I/O  $f_{MAX}$  or  $f_{OUT}$  of the PLL.
- (3) A high input jitter directly affects the PLL output jitter. To have low PLL output clock jitter, you must provide a clean clock source < 120 ps.
- (4)  $f_{REF}$  is  $f_{IN}/N$  when  $N = 1$ .
- (5) Peak-to-peak jitter with a probability level of  $10^{-12}$  (14 sigma, 99.9999999974404% confidence level). The output jitter specification applies to the intrinsic jitter of the PLL, when an input jitter of 30 ps is applied. The external memory interface clock output jitter specifications use a different measurement method and are available in Table 44 on page 52.
- (6) The cascaded PLL specification is only applicable with the following condition:
  - a. Upstream PLL:  $0.59\text{MHz} \leq \text{Upstream PLL BW} < 1$  MHz
  - b. Downstream PLL: Downstream PLL BW > 2 MHz
- (7) High bandwidth PLL settings are not supported in external feedback mode.
- (8) The external memory interface clock output jitter specifications use a different measurement method, which is available in Table 42 on page 50.
- (9) The VCO frequency reported by the Quartus II software in the PLL Usage Summary section of the compilation report takes into consideration the VCO post-scale counter K value. Therefore, if the counter K has a value of 2, the frequency reported can be lower than the  $f_{VCO}$  specification.
- (10) This specification only covers fractional PLL for low bandwidth. The  $f_{VCO}$  for fractional value range 0.05 - 0.95 must be  $\geq 1000$  MHz, while  $f_{VCO}$  for fractional value range 0.20 - 0.80 must be  $\geq 1200$  MHz.
- (11) This specification only covered fractional PLL for low bandwidth. The  $f_{VCO}$  for fractional value range 0.05-0.95 must be  $\geq 1000$  MHz.
- (12) This specification only covered fractional PLL for low bandwidth. The  $f_{VCO}$  for fractional value range 0.20-0.80 must be  $\geq 1200$  MHz.

## DSP Block Specifications

Table 32 lists the Stratix V DSP block performance specifications.

**Table 32. Block Performance Specifications for Stratix V DSP Devices (Part 1 of 2)**

| Mode   | Peformance |         |         |     |               |     |     | Unit |
|--|------------|---------|---------|-----|---------------|-----|-----|------|
|  | C1         | C2, C2L | I2, I2L | C3  | I3, I3L, I3YY | C4  | I4  |      |
| Modes using one DSP                          |            |         |         |     |               |     |     |      |
| Three 9 x 9                                  | 600        | 600     | 600     | 480 | 480           | 420 | 420 | MHz  |
| One 18 x 18                                  | 600        | 600     | 600     | 480 | 480           | 420 | 400 | MHz  |
| Two partial 18 x 18 (or 16 x 16)             | 600        | 600     | 600     | 480 | 480           | 420 | 400 | MHz  |
| One 27 x 27                                  | 500        | 500     | 500     | 400 | 400           | 350 | 350 | MHz  |
| One 36 x 18                                  | 500        | 500     | 500     | 400 | 400           | 350 | 350 | MHz  |
| One sum of two 18 x 18(One sum of 2 16 x 16) | 500        | 500     | 500     | 400 | 400           | 350 | 350 | MHz  |
| One sum of square                            | 500        | 500     | 500     | 400 | 400           | 350 | 350 | MHz  |
| One 18 x 18 plus 36 (a x b) + c              | 500        | 500     | 500     | 400 | 400           | 350 | 350 | MHz  |
| Modes using two DSPs                         |            |         |         |     |               |     |     |      |
| Three 18 x 18                                | 500        | 500     | 500     | 400 | 400           | 350 | 350 | MHz  |
| One sum of four 18 x 18                      | 475        | 475     | 475     | 380 | 380           | 300 | 300 | MHz  |
| One sum of two 27 x 27                       | 465        | 465     | 450     | 380 | 380           | 300 | 290 | MHz  |
| One sum of two 36 x 18                       | 475        | 475     | 475     | 380 | 380           | 300 | 300 | MHz  |
| One complex 18 x 18                          | 500        | 500     | 500     | 400 | 400           | 350 | 350 | MHz  |
| One 36 x 36                                  | 475        | 475     | 475     | 380 | 380           | 300 | 300 | MHz  |

**Table 36. High-Speed I/O Specifications for Stratix V Devices <sup>(1), (2)</sup> (Part 4 of 4)**

| Symbol                        | Conditions                              | C1  |     |           | C2, C2L, I2, I2L |     |           | C3, I3, I3L, I3YY |     |           | C4, I4 |     |           | Unit  |
|-------------------------------|---|-----|-----|-----------|------------------|-----|-----------|-------------------|-----|-----------|--------|-----|-----------|-------|
|                               |   | Min | Typ | Max       | Min              | Typ | Max       | Min               | Typ | Max       | Min    | Typ | Max       |       |
| f <sub>HSDR</sub> (data rate) | SERDES factor J = 3 to 10               | (6) | —   | (8)       | (6)              | —   | (8)       | (6)               | —   | (8)       | (6)    | —   | (8)       | Mbps  |
|                               | SERDES factor J = 2, uses DDR Registers | (6) | —   | (7)       | (6)              | —   | (7)       | (6)               | —   | (7)       | (6)    | —   | (7)       | Mbps  |
|                               | SERDES factor J = 1, uses SDR Register  | (6) | —   | (7)       | (6)              | —   | (7)       | (6)               | —   | (7)       | (6)    | —   | (7)       | Mbps  |
| <b>DPA Mode</b>               |   |     |     |           |                  |     |           |                   |     |           |        |     |           |       |
| DPA run length                | —                                       | —   | —   | 1000<br>0 | —                | —   | 1000<br>0 | —                 | —   | 1000<br>0 | —      | —   | 1000<br>0 | UI    |
| <b>Soft CDR mode</b>          |   |     |     |           |                  |     |           |                   |     |           |        |     |           |       |
| Soft-CDR PPM tolerance        | —                                       | —   | —   | 300       | —                | —   | 300       | —                 | —   | 300       | —      | —   | 300       | ± PPM |
| <b>Non DPA Mode</b>           |   |     |     |           |                  |     |           |                   |     |           |        |     |           |       |
| Sampling Window               | —                                       | —   | —   | 300       | —                | —   | 300       | —                 | —   | 300       | —      | —   | 300       | ps    |

**Notes to Table 36:**

- (1) When J = 3 to 10, use the serializer/deserializer (SERDES) block.
- (2) When J = 1 or 2, bypass the SERDES block.
- (3) This only applies to DPA and soft-CDR modes.
- (4) Clock Boost Factor (W) is the ratio between the input data rate to the input clock rate.
- (5) This is achieved by using the **LVDS** clock network.
- (6) The minimum specification depends on the clock source (for example, the PLL and clock pin) and the clock routing resource (global, regional, or local) that you use. The I/O differential buffer and input register do not have a minimum toggle rate.
- (7) The maximum ideal frequency is the SERDES factor (J) x the PLL maximum output frequency (f<sub>OUT</sub>) provided you can close the design timing and the signal integrity simulation is clean.
- (8) You can estimate the achievable maximum data rate for non-DPA mode by performing link timing closure analysis. You must consider the board skew margin, transmitter delay margin, and receiver sampling margin to determine the maximum data rate supported.
- (9) If the receiver with DPA enabled and transmitter are using shared PLLs, the minimum data rate is 150 Mbps.
- (10) You must calculate the leftover timing margin in the receiver by performing link timing closure analysis. You must consider the board skew margin, transmitter channel-to-channel skew, and receiver sampling margin to determine leftover timing margin.
- (11) The F<sub>MAX</sub> specification is based on the fast clock used for serial data. The interface F<sub>MAX</sub> is also dependent on the parallel clock domain which is design-dependent and requires timing analysis.
- (12) Stratix V RX LVDS will need DPA. For Stratix V TX LVDS, the receiver side component must have DPA.
- (13) Stratix V LVDS serialization and de-serialization factor needs to be x4 and above.
- (14) Requires package skew compensation with PCB trace length.
- (15) Do not mix single-ended I/O buffer within LVDS I/O bank.
- (16) Chip-to-chip communication only with a maximum load of 5 pF.
- (17) When using True LVDS RX channels for emulated LVDS TX channel, only serialization factors 1 and 2 are supported.

Figure 7 shows the dynamic phase alignment (DPA) lock time specifications with the DPA PLL calibration option enabled.

**Figure 7. DPA Lock Time Specification with DPA PLL Calibration Enabled**

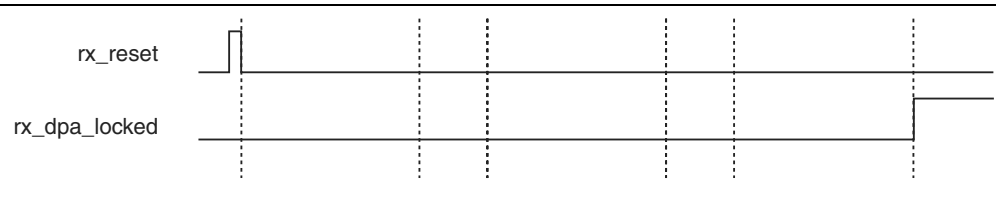


Table 37 lists the DPA lock time specifications for Stratix V devices.

**Table 37. DPA Lock Time Specifications for Stratix V GX Devices Only <sup>(1), (2), (3)</sup>**

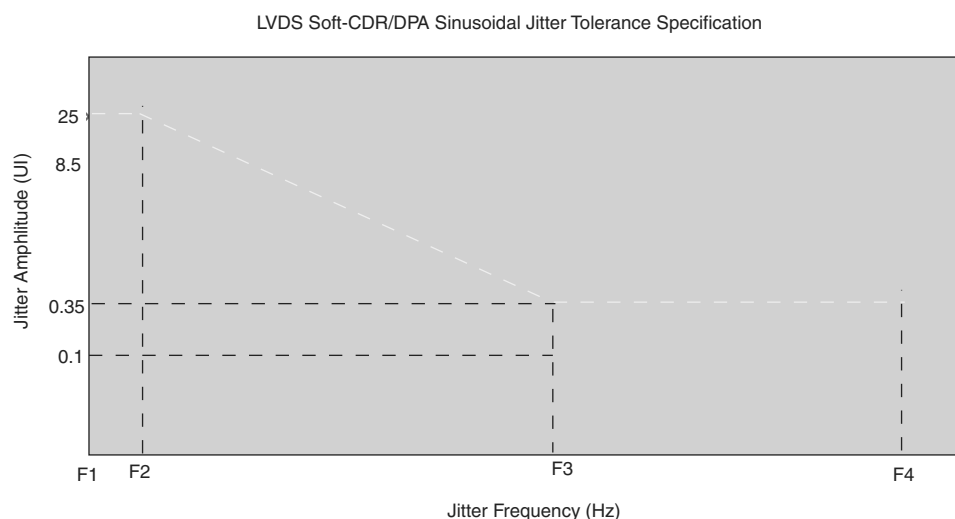
| Standard           | Training Pattern     | Number of Data Transitions in One Repetition of the Training Pattern | Number of Repetitions per 256 Data Transitions <sup>(4)</sup> | Maximum              |
|--------------------|----------------------|--|---|----------------------|
| SPI-4              | 00000000001111111111 | 2  | 128   | 640 data transitions |
| Parallel Rapid I/O | 00001111             | 2  | 128   | 640 data transitions |
|                    | 10010000             | 4  | 64  | 640 data transitions |
| Miscellaneous      | 10101010             | 8  | 32  | 640 data transitions |
|                    | 01010101             | 8  | 32  | 640 data transitions |

**Notes to Table 37:**

- (1) The DPA lock time is for one channel.
- (2) One data transition is defined as a 0-to-1 or 1-to-0 transition.
- (3) The DPA lock time stated in this table applies to both commercial and industrial grade.
- (4) This is the number of repetitions for the stated training pattern to achieve the 256 data transitions.

Figure 8 shows the LVDS soft-clock data recovery (CDR)/DPA sinusoidal jitter tolerance specification for a data rate  $\geq 1.25$  Gbps. Table 38 lists the LVDS soft-CDR/DPA sinusoidal jitter tolerance specification for a data rate  $\geq 1.25$  Gbps.

**Figure 8. LVDS Soft-CDR/DPA Sinusoidal Jitter Tolerance Specification for a Data Rate  $\geq 1.25$  Gbps**



**Table 46. JTAG Timing Parameters and Values for Stratix V Devices**

| Symbol     | Description                              | Min | Max               | Unit |
|------------|--|-----|-------------------|------|
| $t_{JPH}$  | JTAG port hold time                      | 5   | —                 | ns   |
| $t_{JPCO}$ | JTAG port clock to output                | —   | 11 <sup>(1)</sup> | ns   |
| $t_{JPZX}$ | JTAG port high impedance to valid output | —   | 14 <sup>(1)</sup> | ns   |
| $t_{JPXZ}$ | JTAG port valid output to high impedance | —   | 14 <sup>(1)</sup> | ns   |

**Notes to Table 46:**

- (1) A 1 ns adder is required for each  $V_{CCIO}$  voltage step down from 3.0 V. For example,  $t_{JPCO}$  = 12 ns if  $V_{CCIO}$  of the TDO I/O bank = 2.5 V, or 13 ns if it equals 1.8 V.
- (2) The minimum TCK clock period is 167 ns if VCCBAT is within the range 1.2V-1.5V when you perform the volatile key programming.

## Raw Binary File Size

For the POR delay specification, refer to the “POR Delay Specification” section of the “Configuration, Design Security, and Remote System Upgrades in Stratix V Devices”.

Table 47 lists the uncompressed raw binary file (.rbf) sizes for Stratix V devices.

**Table 47. Uncompressed .rbf Sizes for Stratix V Devices**

| Family       | Device | Package                      | Configuration .rbf Size (bits) | IOCSR .rbf Size (bits) <sup>(4), (5)</sup> |
|--------------|--------|------------------------------|--------------------------------|--|
| Stratix V GX | 5SGXA3 | H35, F40, F35 <sup>(2)</sup> | 213,798,880                    | 562,392                                    |
|              |        | H29, F35 <sup>(3)</sup>      | 137,598,880                    | 564,504                                    |
|              | 5SGXA4 | —                            | 213,798,880                    | 563,672                                    |
|              | 5SGXA5 | —                            | 269,979,008                    | 562,392                                    |
|              | 5SGXA7 | —                            | 269,979,008                    | 562,392                                    |
|              | 5SGXA9 | —                            | 342,742,976                    | 700,888                                    |
|              | 5SGXAB | —                            | 342,742,976                    | 700,888                                    |
|              | 5SGXB5 | —                            | 270,528,640                    | 584,344                                    |
|              | 5SGXB6 | —                            | 270,528,640                    | 584,344                                    |
|              | 5SGXB9 | —                            | 342,742,976                    | 700,888                                    |
|              | 5SGXBB | —                            | 342,742,976                    | 700,888                                    |
| Stratix V GT | 5SGTC5 | —                            | 269,979,008                    | 562,392                                    |
|              | 5SGTC7 | —                            | 269,979,008                    | 562,392                                    |
| Stratix V GS | 5SGSD3 | —                            | 137,598,880                    | 564,504                                    |
|              | 5SGSD4 | F1517                        | 213,798,880                    | 563,672                                    |
|              |        | —                            | 137,598,880                    | 564,504                                    |
|              | 5SGSD5 | —                            | 213,798,880                    | 563,672                                    |
|              | 5SGSD6 | —                            | 293,441,888                    | 565,528                                    |
|              | 5SGSD8 | —                            | 293,441,888                    | 565,528                                    |

**Table 47. Uncompressed .rbf Sizes for Stratix V Devices**

| Family                     | Device | Package | Configuration .rbf Size (bits) | IOCSR .rbf Size (bits) <sup>(4), (5)</sup> |
|----------------------------|--------|---------|--------------------------------|--|
| Stratix V E <sup>(1)</sup> | 5SEE9  | —       | 342,742,976                    | 700,888                                    |
|                            | 5SEEB  | —       | 342,742,976                    | 700,888                                    |

**Notes to Table 47:**

- (1) Stratix V E devices do not have PCI Express® (PCIe®) hard IP. Stratix V E devices do not support the CvP configuration scheme.
- (2) 36-transceiver devices.
- (3) 24-transceiver devices.
- (4) File size for the periphery image.
- (5) The IOCSR .rbf size is specifically for the CvP feature.

Use the data in Table 47 to estimate the file size before design compilation. Different configuration file formats, such as a hexadecimal (.hex) or tabular text file (.tff) format, have different file sizes. For the different types of configuration file and file sizes, refer to the Quartus II software. However, for a specific version of the Quartus II software, any design targeted for the same device has the same uncompressed configuration file size. If you are using compression, the file size can vary after each compilation because the compression ratio depends on your design.



For more information about setting device configuration options, refer to *Configuration, Design Security, and Remote System Upgrades in Stratix V Devices*. For creating configuration files, refer to the *Quartus II Help*.

Table 48 lists the minimum configuration time estimates for Stratix V devices.

**Table 48. Minimum Configuration Time Estimation for Stratix V Devices**

| Variant | Member Code | Active Serial <sup>(1)</sup> |            |                     | Fast Passive Parallel <sup>(2)</sup> |            |                     |
|---------|-------------|------------------------------|------------|---------------------|--------------------------------------|------------|---------------------|
|         |             | Width                        | DCLK (MHz) | Min Config Time (s) | Width                                | DCLK (MHz) | Min Config Time (s) |
| GX      | A3          | 4                            | 100        | 0.534               | 32                                   | 100        | 0.067               |
|         |             | 4                            | 100        | 0.344               | 32                                   | 100        | 0.043               |
|         | A4          | 4                            | 100        | 0.534               | 32                                   | 100        | 0.067               |
|         | A5          | 4                            | 100        | 0.675               | 32                                   | 100        | 0.084               |
|         | A7          | 4                            | 100        | 0.675               | 32                                   | 100        | 0.084               |
|         | A9          | 4                            | 100        | 0.857               | 32                                   | 100        | 0.107               |
|         | AB          | 4                            | 100        | 0.857               | 32                                   | 100        | 0.107               |
|         | B5          | 4                            | 100        | 0.676               | 32                                   | 100        | 0.085               |
|         | B6          | 4                            | 100        | 0.676               | 32                                   | 100        | 0.085               |
|         | B9          | 4                            | 100        | 0.857               | 32                                   | 100        | 0.107               |
|         | BB          | 4                            | 100        | 0.857               | 32                                   | 100        | 0.107               |
| GT      | C5          | 4                            | 100        | 0.675               | 32                                   | 100        | 0.084               |
|         | C7          | 4                            | 100        | 0.675               | 32                                   | 100        | 0.084               |

**Table 49. DCLK-to-DATA[] Ratio <sup>(1)</sup> (Part 2 of 2)**

| Configuration Scheme | Decompression | Design Security | DCLK-to-DATA[] Ratio |
|----------------------|---------------|-----------------|----------------------|
| FPP ×32              | Disabled      | Disabled        | 1                    |
|                      | Disabled      | Enabled         | 4                    |
|                      | Enabled       | Disabled        | 8                    |
|                      | Enabled       | Enabled         | 8                    |

**Note to Table 49:**

- (1) Depending on the DCLK-to-DATA[] ratio, the host must send a DCLK frequency that is r times the data rate in bytes per second (Bps), or words per second (Wps). For example, in FPP ×16 when the DCLK-to-DATA[] ratio is 2, the DCLK frequency must be 2 times the data rate in Wps. Stratix V devices use the additional clock cycles to decrypt and decompress the configuration data.



If the DCLK-to-DATA[] ratio is greater than 1, at the end of configuration, you can only stop the DCLK (DCLK-to-DATA[] ratio – 1) clock cycles after the last data is latched into the Stratix V device.

Figure 11 shows the configuration interface connections between the Stratix V device and a MAX II or MAX V device for single device configuration.

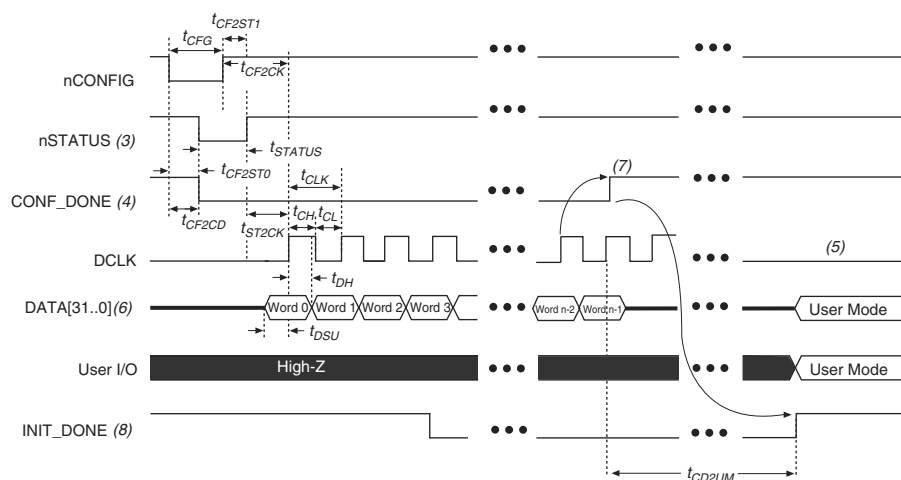
**Figure 11. Single Device FPP Configuration Using an External Host****Notes to Figure 11:**

- (1) Connect the resistor to a supply that provides an acceptable input signal for the Stratix V device.  $V_{CCPGM}$  must be high enough to meet the  $V_{IH}$  specification of the I/O on the device and the external host. Altera recommends powering up all configuration system I/Os with  $V_{CCPGM}$ .
- (2) You can leave the nCEO pin unconnected or use it as a user I/O pin when it does not feed another device's nCE pin.
- (3) The MSEL pin settings vary for different data width, configuration voltage standards, and POR delay. To connect MSEL, refer to the MSEL Pin Settings section of the "Configuration, Design Security, and Remote System Upgrades in Stratix V Devices" chapter.
- (4) If you use FPP ×8, use DATA[7..0]. If you use FPP ×16, use DATA[15..0].

## FPP Configuration Timing when DCLK-to-DATA [] = 1

Figure 12 shows the timing waveform for FPP configuration when using a MAX II or MAX V device as an external host. This waveform shows timing when the DCLK-to-DATA [] ratio is 1.

**Figure 12. FPP Configuration Timing Waveform When the DCLK-to-DATA[] Ratio is 1 <sup>(1), (2)</sup>**



### Notes to Figure 12:

- (1) Use this timing waveform when the DCLK-to-DATA [] ratio is 1.
- (2) The beginning of this waveform shows the device in user mode. In user mode, nCONFIG, nSTATUS, and CONF\_DONE are at logic-high levels. When nCONFIG is pulled low, a reconfiguration cycle begins.
- (3) After power-up, the Stratix V device holds nSTATUS low for the time of the POR delay.
- (4) After power-up, before and during configuration, CONF\_DONE is low.
- (5) Do not leave DCLK floating after configuration. DCLK is ignored after configuration is complete. It can toggle high or low if required.
- (6) For FPP x16, use DATA [15..0]. For FPP x8, use DATA [7..0]. DATA [31..0] are available as a user I/O pin after configuration. The state of this pin depends on the dual-purpose pin settings.
- (7) To ensure a successful configuration, send the entire configuration data to the Stratix V device. CONF\_DONE is released high when the Stratix V device receives all the configuration data successfully. After CONF\_DONE goes high, send two additional falling edges on DCLK to begin initialization and enter user mode.
- (8) After the option bit to enable the INIT\_DONE pin is configured into the device, the INIT\_DONE goes low.



Table 50 lists the timing parameters for Stratix V devices for FPP configuration when the DCLK-to-DATA [] ratio is 1.

**Table 50. FPP Timing Parameters for Stratix V Devices <sup>(1)</sup>**

| Symbol                            | Parameter   | Minimum   | Maximum              | Units |
|-----------------------------------|---|---|----------------------|-------|
| t <sub>CF2CD</sub>                | nCONFIG low to CONF_DONE low                      | —   | 600                  | ns    |
| t <sub>CF2ST0</sub>               | nCONFIG low to nSTATUS low                        | —   | 600                  | ns    |
| t <sub>CFG</sub>                  | nCONFIG low pulse width                           | 2   | —                    | μs    |
| t <sub>STATUS</sub>               | nSTATUS low pulse width                           | 268   | 1,506 <sup>(2)</sup> | μs    |
| t <sub>CF2ST1</sub>               | nCONFIG high to nSTATUS high                      | —   | 1,506 <sup>(3)</sup> | μs    |
| t <sub>CF2CK</sub> <sup>(6)</sup> | nCONFIG high to first rising edge on DCLK         | 1,506   | —                    | μs    |
| t <sub>ST2CK</sub> <sup>(6)</sup> | nSTATUS high to first rising edge of DCLK         | 2   | —                    | μs    |
| t <sub>DSU</sub>                  | DATA [] setup time before rising edge on DCLK     | 5.5   | —                    | ns    |
| t <sub>DH</sub>                   | DATA [] hold time after rising edge on DCLK       | 0   | —                    | ns    |
| t <sub>CH</sub>                   | DCLK high time                                    | $0.45 \times 1/f_{\text{MAX}}$                                    | —                    | s     |
| t <sub>CL</sub>                   | DCLK low time                                     | $0.45 \times 1/f_{\text{MAX}}$                                    | —                    | s     |
| t <sub>CLK</sub>                  | DCLK period                                       | $1/f_{\text{MAX}}$  | —                    | s     |
| f <sub>MAX</sub>                  | DCLK frequency (FPP $\times 8/\times 16$ )        | —   | 125                  | MHz   |
|                                   | DCLK frequency (FPP $\times 32$ )                 | —   | 100                  | MHz   |
| t <sub>CD2UM</sub>                | CONF_DONE high to user mode <sup>(4)</sup>        | 175   | 437                  | μs    |
| t <sub>CD2CU</sub>                | CONF_DONE high to CLKUSR enabled                  | 4 $\times$ maximum DCLK period                                    | —                    | —     |
| t <sub>CD2UMC</sub>               | CONF_DONE high to user mode with CLKUSR option on | t <sub>CD2CU</sub> + (8576 $\times$ CLKUSR period) <sup>(5)</sup> | —                    | —     |

**Notes to Table 50:**

- (1) Use these timing parameters when the decompression and design security features are disabled.
- (2) This value is applicable if you do not delay configuration by extending the nCONFIG or nSTATUS low pulse width.
- (3) This value is applicable if you do not delay configuration by externally holding the nSTATUS low.
- (4) The minimum and maximum numbers apply only if you chose the internal oscillator as the clock source for initializing the device.
- (5) To enable the CLKUSR pin as the initialization clock source and to obtain the maximum frequency specification on these pins, refer to the Initialization section of the “Configuration, Design Security, and Remote System Upgrades in Stratix V Devices” chapter.
- (6) If nSTATUS is monitored, follow the t<sub>ST2CK</sub> specification. If nSTATUS is not monitored, follow the t<sub>CF2CK</sub> specification.

### FPP Configuration Timing when DCLK-to-DATA [] > 1

Figure 13 shows the timing waveform for FPP configuration when using a MAX II device, MAX V device, or microprocessor as an external host. This waveform shows timing when the DCLK-to-DATA [] ratio is more than 1.

## Active Serial Configuration Timing

Table 52 lists the DCLK frequency specification in the AS configuration scheme.

**Table 52. DCLK Frequency Specification in the AS Configuration Scheme <sup>(1), (2)</sup>**

| Minimum | Typical | Maximum | Unit |
|---------|---------|---------|------|
| 5.3     | 7.9     | 12.5    | MHz  |
| 10.6    | 15.7    | 25.0    | MHz  |
| 21.3    | 31.4    | 50.0    | MHz  |
| 42.6    | 62.9    | 100.0   | MHz  |

**Notes to Table 52:**

- (1) This applies to the DCLK frequency specification when using the internal oscillator as the configuration clock source.
- (2) The AS multi-device configuration scheme does not support DCLK frequency of 100 MHz.

Figure 14 shows the single-device configuration setup for an AS ×1 mode.

**Figure 14. AS Configuration Timing**



**Notes to Figure 14:**

- (1) If you are using AS ×4 mode, this signal represents the AS\_DATA [3 : 0] and EPCQ sends in 4-bits of data for each DCLK cycle.
- (2) The initialization clock can be from internal oscillator or CLKUSR pin.
- (3) After the option bit to enable the INIT\_DONE pin is configured into the device, the INIT\_DONE goes low.

Table 53 lists the timing parameters for AS ×1 and AS ×4 configurations in Stratix V devices.

**Table 53. AS Timing Parameters for AS ×1 and AS ×4 Configurations in Stratix V Devices <sup>(1), (2)</sup> (Part 1 of 2)**

| Symbol          | Parameter                                   | Minimum | Maximum | Units |
|-----------------|---|---------|---------|-------|
| t <sub>CO</sub> | DCLK falling edge to AS_DATA0/ASDO output   | —       | 2       | ns    |
| t <sub>SU</sub> | Data setup time before falling edge on DCLK | 1.5     | —       | ns    |
| t <sub>H</sub>  | Data hold time after falling edge on DCLK   | 0       | —       | ns    |

## Remote System Upgrades

Table 56 lists the timing parameter specifications for the remote system upgrade circuitry.

**Table 56. Remote System Upgrade Circuitry Timing Specifications**

| Parameter                | Minimum | Maximum | Unit |
|--------------------------|---------|---------|------|
| $t_{RU\_nCONFIG}^{(1)}$  | 250     | —       | ns   |
| $t_{RU\_nRSTIMER}^{(2)}$ | 250     | —       | ns   |

**Notes to Table 56:**

- (1) This is equivalent to strobing the reconfiguration input of the ALTREMOTEM\_UPDATE megafunction high for the minimum timing specification. For more information, refer to the Remote System Upgrade State Machine section of the “Configuration, Design Security, and Remote System Upgrades in Stratix V Devices” chapter.
- (2) This is equivalent to strobing the reset\_timer input of the ALTREMOTEM\_UPDATE megafunction high for the minimum timing specification. For more information, refer to the User Watchdog Timer section of the “Configuration, Design Security, and Remote System Upgrades in Stratix V Devices” chapter.

## User Watchdog Internal Circuitry Timing Specification

Table 57 lists the operating range of the 12.5-MHz internal oscillator.

**Table 57. 12.5-MHz Internal Oscillator Specifications**

| Minimum | Typical | Maximum | Units |
|---------|---------|---------|-------|
| 5.3     | 7.9     | 12.5    | MHz   |

## I/O Timing

Altera offers two ways to determine I/O timing—the Excel-based I/O Timing and the Quartus II Timing Analyzer.

Excel-based I/O timing provides pin timing performance for each device density and speed grade. The data is typically used prior to designing the FPGA to get an estimate of the timing budget as part of the link timing analysis. The Quartus II Timing Analyzer provides a more accurate and precise I/O timing data based on the specifics of the design after you complete place-and-route.



You can download the Excel-based I/O Timing spreadsheet from the Stratix V Devices Documentation web page.

## Programmable IOE Delay

Table 58 lists the Stratix V IOE programmable delay settings.

**Table 58. IOE Programmable Delay for Stratix V Devices (Part 1 of 2)**

| Parameter<br>(1) | Available<br>Settings | Min<br>Offset<br>(2) | Fast Model |            | Slow Model |       |       |       |       |             |       |      |
|------------------|-----------------------|----------------------|------------|------------|------------|-------|-------|-------|-------|-------------|-------|------|
|                  |                       |                      | Industrial | Commercial | C1         | C2    | C3    | C4    | I2    | I3,<br>I3YY | I4    | Unit |
| D1               | 64                    | 0                    | 0.464      | 0.493      | 0.838      | 0.838 | 0.924 | 1.011 | 0.844 | 0.921       | 1.006 | ns   |
| D2               | 32                    | 0                    | 0.230      | 0.244      | 0.415      | 0.415 | 0.459 | 0.503 | 0.417 | 0.456       | 0.500 | ns   |

Table 60. Glossary (Part 2 of 4)

| Letter                | Subject                    | Definitions   |
|-----------------------|----------------------------|---|
| G<br>H<br>I           | —                          | —   |
| J                     | JTAG Timing Specifications | <p>High-speed I/O block—Deserialization factor (width of parallel data bus).</p> <p>JTAG Timing Specifications:</p>   |
| K<br>L<br>M<br>N<br>O | —                          | —   |
| P                     | PLL Specifications         | <p><b>Diagram of PLL Specifications <sup>(1)</sup></b></p> <p><b>Note:</b><br/>(1) Core Clock can only be fed by dedicated clock input pins or PLL outputs.</p> |
| Q                     | —                          | —   |
| R                     | R <sub>L</sub>             | Receiver differential input discrete resistor (external to the Stratix V device).   |

Table 60. Glossary (Part 3 of 4)

| Letter | Subject                                      | Definitions  |
|--------|--|--|
| S      | SW (sampling window)                         | <p>Timing Diagram—the period of time during which the data must be valid in order to capture it correctly. The setup and hold times determine the ideal strobe position within the sampling window, as shown:</p>    |
|        | Single-ended voltage referenced I/O standard | <p>The JEDEC standard for <b>SSTL</b> and <b>HSTL</b> I/O defines both the AC and DC input signal values. The AC values indicate the voltage levels at which the receiver must meet its timing specifications. The DC values indicate the voltage levels at which the final logic state of the receiver is unambiguously defined. After the receiver input has crossed the AC value, the receiver changes to the new logic state.</p> <p>The new logic state is then maintained as long as the input stays beyond the DC threshold. This approach is intended to provide predictable receiver timing in the presence of input waveform ringing:</p> <p><i>Single-Ended Voltage Referenced I/O Standard</i></p>  |
| T      | $t_c$  | High-speed receiver and transmitter input and output clock period.   |
|        | TCCS (channel-to-channel-skew)               | The timing difference between the fastest and slowest output edges, including $t_{CO}$ variation and clock skew, across channels driven by the same PLL. The clock is included in the TCCS measurement (refer to the <i>Timing Diagram</i> figure under <b>SW</b> in this table).  |
|        | $t_{DUTY}$                                   | <p>High-speed I/O block—Duty cycle on the high-speed transmitter output clock.</p> <p><b>Timing Unit Interval (TUI)</b></p> <p>The timing budget allowed for skew, propagation delays, and the data sampling window. (TUI = <math>1/(\text{receiver input clock frequency multiplication factor}) = t_c/w</math>)</p>  |
|        | $t_{FALL}$                                   | Signal high-to-low transition time (80-20%)  |
|        | $t_{INCCJ}$                                  | Cycle-to-cycle jitter tolerance on the PLL clock input.  |
|        | $t_{OUTPJ\_IO}$                              | Period jitter on the general purpose I/O driven by a PLL.  |
|        | $t_{OUTPJ\_DC}$                              | Period jitter on the dedicated clock output driven by a PLL.   |
|        | $t_{RISE}$                                   | Signal low-to-high transition time (20-80%)  |
| U      | —  | —  |